

#### Replaces DS5914-2

# **Gate Turn-off Thyristor**

DS5914-3 November 2021 (LN41298)

#### FEATURES

- Double Side Cooling
- High Reliability In Service
- High Voltage Capability
- Fault Protection Without Fuses
- High Surge Current Capability
- Turn-off Capability Allows Reduction in Equipment Size and Weight. Low Noise Emission Reduces Acoustic Cladding Necessary For Environmental Requirements

#### **APPLICATIONS**

- Variable speed AC motor drive inverters (VSD-AC) including Traction drives
- Uninterruptable Power Supplies
- High Voltage Converters
- Choppers
- Welding
- Induction Heating
- DC/DC Converters

### **KEY PARAMETERS**

Тсм	3000A
	4500V
	950A
dV <sub>D</sub> /dt*	1000V/µs
dl⊤/dt	400A/us



Fig. 1 Package outline

#### **VOLTAGE RATINGS**

Type Number Repetitive Peak Off-state   Voltage VDRM (V)		Repetitive Peak Reverse Voltage V <sub>RRM</sub> (V)	Conditions
DG808BC45	4500	16	$T_{vj} = 125$ °C, $I_{DM} = 100$ mA, $I_{RRM} = 50$ mA

#### **CURRENT RATINGS**

Symbol	Parameter	Conditions	Max.	Units
Ітсм	Repetitive peak controllable on-state current	$V_D = 66\% V_{DRM}, T_j = 125^{\circ}C,$ $dI_{GQ}/dt = 40A/\mu s, C_s = 4 \ \mu F$	3000	А
I <sub>T(AV)</sub>	Mean on-state current	$T_{HS}$ = 80°C, Double side cooled. Half sine 50Hz	950	А
I <sub>T(RMS)</sub>	RMS on-state current	$T_{HS}$ = 80°C, Double side cooled. Half sine 50Hz	1490	А

#### SURGE RATINGS

Symbol	Parameter	Test Conditions	Max.	Units
ITSM	Surge (non repetitive) on-state current	10ms half sine. $T_j = 125^{\circ}C$	16.0	kA
l <sup>2</sup> t	I <sup>2</sup> t for fusing	10ms half sine. $T_j = 125^{\circ}C$	1.28	MA <sup>2</sup> s
di⊤/dt	Critical rate of rise of on-state current	$V_D$ = 3000V, I <sub>T</sub> = 3000A, T <sub>j</sub> = 125°C, I <sub>FG</sub> > 40A, Rise time > 1.0 µs	400	A/µs
al) ( /alt	Data of rise of off state values	To 66% Vdrm; Rgk $\leq 1.5\Omega$ , Tj = 125°C	100	V/µs
av <sub>D</sub> /at	Rate of fise of off-state voltage	To 66% Vdrm; $V_{RG} \leq -2V$ , $T_j = 125^{\circ}C$	1000	V/µs
Ls	Peak stray inductance in snubber circuit	IT = 3000A, $V_D = V_{DRM}$ , Tj = 125°C, dI <sub>GQ</sub> = 40A/us, C <sub>S</sub> = 4.0uF	200	nH

### **GATE RATINGS**

Symbol	Parameter	Test Conditions	Min.	Max.	Units
Vrgm	Peak reverse gate voltage	This value may exceeded during turn-off	-	16	V
IFGM	Peak forward gate current		-	100	А
P <sub>FG(AV)</sub>	Average forward gate power		-	20	W
Prgm	Peak reverse gate power		-	24	kW
digq/dt	Rate of rise of reverse gate current		30	60	A/µs
t <sub>ON(min)</sub>	Minimum permissible on time		50	-	μS
toff(min)	Minimum permissible off time		100	-	μS

## THERMAL AND MECHANICAL RATINGS

Symbol	Parameter	Test Conditions		Min.	Max.	Units
	Thermal resistance – junction to	Double side cooled	DC	-	0.014	°C/W
Rth(j-hs)	heatsink surface	Single side seeled	Anode DC	-	0.0233	°C/W
			Cathode DC	-	0.035	°C/W
R <sub>th(c-hs)</sub>	Contact thermal resistance	Clamping force 36.0kN With mounting compound	Per contact	-	0.0036	°C/W
T <sub>vj</sub>	Virtual junction temperature	On-state (conducting)		-40	125	°C
T <sub>op</sub> /T <sub>stg</sub>	Operating junction/storage temperature range			-40	125	°C
Fm	Clamping force			28.0	44.0	kN

### CHARACTERISTICS

### Tj =125°C unless stated otherwise

Symbol	Parameter	Test Conditions	Min.	Max.	Units
V <sub>TM)</sub>	On-state voltage	At 3000A peak, $I_{G(ON)} = 10A \text{ d.c.}$	-	3.75	V
Ідм	Peak off-state current	$V_{DRM} = 4500V, V_{RG} = 0V$	-	100	mA
I <sub>RRM</sub>	Peak reverse current	V <sub>RRM</sub> = 16V	-	50	mA
V <sub>GT</sub>	Gate trigger voltage	V <sub>D</sub> = 24V, I <sub>T</sub> = 100A, Tj = 25°C	-	1.2	V
lgт	Gate trigger current	$V_D = 24V, I_T = 100A, Tj = 25^{\circ}C$	-	3.5	А
I <sub>RGM</sub>	Reverse gate cathode current	V <sub>RGM</sub> = 16V, No gate/cathode resistor	-	10	mA
Eon	Turn-on Energy	V <sub>D</sub> = 3000V	-	2860	mJ
td	Delay time	I⊤ = 3000A, dI⊤/dt = 300A/µs	-	2.1	μs
tr	Rise time	$I_{FG} = 40A$ , rise time < 1.0µs	-	4.8	μs
EOFF	Turn-off energy		-	12000	mJ
t <sub>gs</sub>	Storage time		-	25	μs
t <sub>gf</sub>	Fall time	I <sub>T</sub> = 3000A, V <sub>DM</sub> = VDRM		2	μs
t <sub>gq</sub>	Gate controlled turn-off time	Snubber Cap Cs = 4.0µC	-	27	μs
Q <sub>GQ</sub>	Turn-off gate charge	di <sub>GQ</sub> /dt = 40A/us		12000	μC
Q <sub>GQT</sub>	Total turn-off gate charge			24000	μC
I <sub>GQM</sub>	Peak reverse gate current		-	800	А



double side cooled





Fig.8 Turn-on energy vs forward gate current



Fig.9 Turn-on energy vs rate of rise of on-state current



Fig.12 Turn-off energy vs on-state current

Fig.13 Turn-off energy loss vs rate of rise of reverse gate current





current



Fig.17 Gate fall time vs on-state current



![](_page_8_Figure_1.jpeg)

resistance

![](_page_9_Figure_1.jpeg)

Fig.24 General switching waveforms

### PACKAGE DETAILS

For further package information, please contact Customer Services. All dimensions in mm, unless stated otherwise. DO NOT SCALE.

![](_page_10_Figure_3.jpeg)

Fig.31 Package outline

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